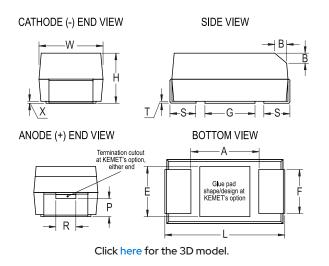


## T493X476M025AH6420

T493 HRA, Tantalum, MnO2 Tantalum, HRA, 47 uF, 20%, 25 VDC, SMD, MnO2, Molded, High Reliability, N/A, 300 mOhms, 7343, 4.3 mm, 1.3 mm





General Information	
Series	T493 HRA
Dielectric	MnO2 Tantalum
Style	SMD Chip
Description	SMD, MnO2, Molded, High Reliability
Features	High Reliability
RoHS	No
Prop 65	WARNING: Cancer and reproductive harm - https://www.p65warnings.ca.gov /
SCIP Number	1dd2e1b8-26dd-4d52-927c-6f9 d519011aa
Termination	Tin Lead (SnPb)
AEC-Q200	No
Typical Component Weight	654.04 mg

Dimensions	
L	7.3mm +/-0.3mm
W	4.3mm +/-0.3mm
Н	4mm +/-0.3mm
Т	0.13mm REF
S	1.3mm +/-0.3mm
F	2.4mm +/-0.1mm
A	3.8mm MIN
В	0.5mm +/-0.15mm
E	3.5mm REF
G	3.5mm REF
Р	1.7mm REF
R	1mm REF
X	0.1mm +/-0.1mm REF

L	7.3mm +/-0.3mm	Cap
W	4.3mm +/-0.3mm	Tole
Н	4mm +/-0.3mm	Volta
Т	0.13mm REF	Tem
S	1.3mm +/-0.3mm	Rate
F	2.4mm +/-0.1mm	Dissi
Α	3.8mm MIN	Failu
В	0.5mm +/-0.15mm	ESR
E	3.5mm REF	Ripp
G	3.5mm REF	Leak
Р	1.7mm REF	Test
R	1mm REF	
Χ	0.1mm +/-0.1mm REF	

Specifications	
Capacitance	47 uF
Tolerance	20%
Voltage DC	25 VDC (85C), 16.75 VDC (125C)
Temperature Range	-55/+125°C
Rated Temperature	85°C
Dissipation Factor	6% 120Hz 25C
Failure Rate	N/A
ESR	0.3 Ohms (100kHz 25C)
Ripple Current	742 mA (rms, 100kHz 25C)
Leakage Current	11.8 uA (5min 25°C)
Testing and Reliability	10 Cycles Surge Current Testing At -55C And +85C Before Weibull

Packaging Specifications	
Packaging	T&R, 178mm
Packaging Quantity	500

Statements of suitability for certain applications are based on our knowledge of typical operating conditions for such applications, but are not intended to constitute - and we specifically disclaim - any warranty concerning suitability for a specific customer application or use. This Information is intended for use only by customers who have the requisite experience and capability to determine the correct products for their application. Any technical advice inferred from this Information or otherwise provided by us with reference to the use of our products is given gratis, and we assume no obligation or liability for the advice given or results obtained.

Generated 10/16/2025 © 2006 - 2025 YAGEO

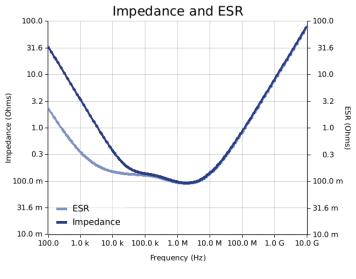


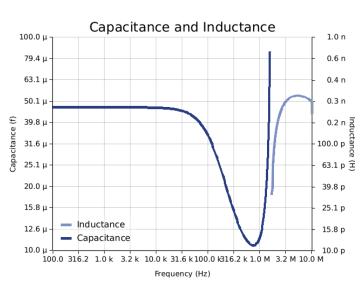


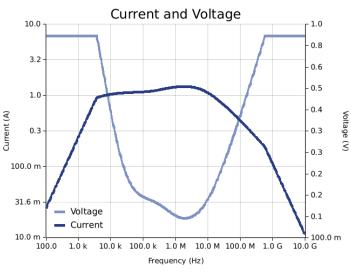
T493 HRA, Tantalum, MnO2 Tantalum, HRA, 47 uF, 20%, 25 VDC, SMD, MnO2, Molded, High Reliability, N/A, 300 mOhms, 7343, 4.3 mm, 1.3 mm

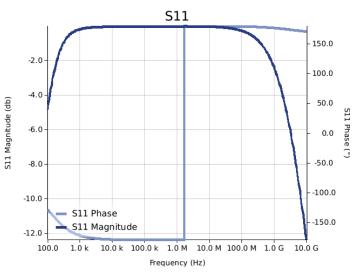
## **Simulations**

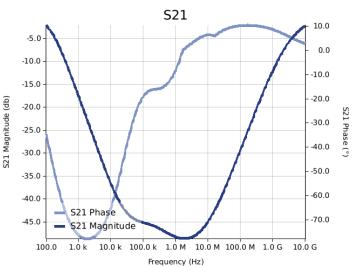
For the complete simulation environment please visit Y-SIM.











Generated 10/16/2025 © 2006 - 2025 YAGEO



## T493X476M025AH6420

T493 HRA, Tantalum, MnO2 Tantalum, HRA, 47 uF, 20%, 25 VDC, SMD, MnO2, Molded, High Reliability, N/A, 300 mOhms, 7343, 4.3 mm, 1.3 mm

## These are simulations.

This is not a specification!

The responses shown represent the typical response for each part type. Specific responses may vary, depending on manufacturing variation affects of all parameters involved, including the specified tolerances applied to capacitance and unspecified variations of ESR, ESL, and leakage resistance.

The responses shown do not represent a specified or implied maximum capability of the device for all applications.

- The ESR used for ripple "Ripple Current/Voltage vs. Frequency" plots is the ESR at ambient temperature.

- The ESR in the "Temperature Rise vs. Ripple Current" plots is the ESR at ambient temperature. The ESR in the "Temperature Rise vs. Ripple Current" plots is adjusted to each incremental temperature rise before the power and ripple current is calculated. The effects shown herein are based on measured data from a multiple part sample of the parts in question. Ripple capability of this device will be factored by thermal resistance (Rth) created by circuit traces (addi affects of all parameters involved, including the specified tolerances applied to capacitance and unspecified variations of ESR, ESL, and leakage resistance.

  The peak voltages generated in the "Temperature Rise vs. Combined Ripple Currents" plot are calculated for each frequency and are not combined with voltages
- generated at any other harmonics.

   Please consult with the catalog or field applications engineer for maximum capability of the device in specific applications.

All product information and data (collectively, the "Information") are subject to change without notice.

KEMET K-SIM is designed to simulate behavior of components with respect to frequency, ambient temperature, and DC bias levels. The responses shown represent the typical response for each part type. Specific responses may vary, depending on manufacturing variation effects of all parameters involved, including the specified tolerances applied to capacitance and unspecified variations of ESR, ESL, and leakage resistance.

All Information given herein is believed to be accurate and reliable, but is presented without guarantee, warranty, or responsibility of any kind, expressed or implied. Statements of suitability for certain applications are based on our knowledge of typical operating conditions for such applications, but are not intended to constitute – and we specifically disclaim – any warranty concerning suitability for a specific customer application or use. This Information is intended for use only by customers who have the requisite experience and capability to determine the correct products for their application. Any technical advice inferred from this Information or otherwise provided by us with reference to the use of our products is given gratis, and we assume no obligation or liability for the advice given or results obtained.

If you have any questions please contact K-SIM.

Generated 10/16/2025 © 2006 - 2025 YAGEO